

*“A Reliable
and Responsive
Adhesive
Company.”*

Bondfilm™ 8060 is a glass fabric supported, low temperature curing, epoxy film adhesive. It is formulated for lid sealing microelectronics packages. It also offers a controlled bondline thickness and is an excellent choice for substrate attachments.

Adhesive Properties

Color:	White
Work Life @ 25°C:	24 hours
Cure:	2 hours @ 100°C
Service Temperature Range:	-40°C to 150°C
Lap Shear Strength @ 25°C (Al to Al):	8000 psi
@ 25°C (Au to Au):	1500 psi
Glass Transition Temperature (Tg):	110°C
Weight Loss @ 300°C:	1.2%
Coefficient of Thermal Expansion:	
Below Tg:	104×10^{-6} in/in/°C
Above Tg:	524×10^{-6} in/in/°C
Shelf Life:	1 year @ -40°C 6 months @ 5°C

Adhesive properties are not intended to be used as specification limits.

Bondline™
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INSTRUCTIONS:

Place film adhesive between surfaces to be bonded. Apply continuous pressure of 1-5 psi during cure, using weight or spring loaded clamp.

AVAILABILITY:

Bondfilm™ 8060 epoxy film is available in sheet stock and die cut preforms. Die cut preforms. Die cut preforms are cut to customer specifications. Width and length tolerances are $\pm .005$ inch. Thickness tolerance $\pm .001$ inch.

STORAGE LIFE:

Storage life of sheet stock is 10 days, when stored at room temperature. Storage life is 1 year at -40°C or colder.

CAUTION: For industrial use only. People with sensitive skin may have a reaction to this adhesive. Avoid skin contact. Wash all areas with soap and water immediately if contact does occur. It is important to refer to Material Safety Data Sheet (MSDS) OSHA for more details.

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